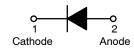


Schottky Barrier Rectifiers, Surface Mount, 2 A, 20 V - 150 V

SS22FA - S215FA

Features

- Low Power Loss, High Efficiency
- Guard Ring for Overvoltage Protection
- High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- Green Molding Compound
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



Rectifier



SOD-123FL CASE 425AB

MARKING DIAGRAM



Band Indicates Cathode

&Y = Binary Calendar Year Coding Scheme

&Z = Assembly Plant Code

= Specific Device Code

(see "Top Mark" in the table below)

&G = Single Digit Weekly Date Code

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]		
SS22FA	22L	SOD-123FL	3000 / Tape & Reel		
NRVBSS22FA		(Pb-Free)			
SS23FA	23L	SOD-123FL	3000 / Tape & Reel		
NRVBSS23FA		(Pb-Free)			
SS25FA	25L	SOD-123FL	3000 / Tape & Reel		
NRVBSS25FA		(Pb-Free)			
SS29FA	29L	SOD-123FL	3000 / Tape & Reel		
NRVBSS29FA		(Pb-Free)			
S210FA	20L	SOD-123FL	3000 / Tape & Reel		
NRVBS210FA		(Pb-Free)			
S215FA	2AL	SOD-123FL	3000 / Tape & Reel		
NRVBS215FA		(Pb-Free)			

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

1

SS22FA - S215FA

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

		Value						
Symbol	Parameter	SS22FA	SS23FA	SS25FA	SS29FA	S210FA	S215FA	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	20	30	50	90	100	150	V
V _{RMS}	RMS Reverse Voltage	IS Reverse Voltage 14 21 35 63 70 105		V				
V _R	DC Blocking Voltage	20	30	50	90	100	150	V
I _{F(AV)}	Average Forward Rectified Current	2		Α				
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	50		Α				
T _J	Operating Junction Temperature Range	-55 to +125 -55 to +150		°C				
T _{STG}	Storage Temperature Range	-55 to +150		°C				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
Ψ_{JL}	Junction-to-Lead Thermal Characteristics	16	°C/W
$R_{ hetaJA}$	Junction-to-Ambient Thermal Resistance	152	°C/W

^{1.} Per JESD51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}\text{C unless otherwise noted})$

			Value						
Symbol	Parameter	Conditions	SS22FA	SS23FA	SS25FA	SS29FA	S210FA	S215FA	Unit
V _F	Maximum Instantaneous Forward Voltage (Note 2)	I _F = 2 A	0.	50	0.70	0.	85	0.95	V
I _R	Maximum Reverse Current at	T _J = 25°C	0.4		0.1		mA		
	Rated V _R		1	5	10				
							5		
CJ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	12	20	93	6	2	48	pF
T _{rr}	Typical Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A	1	0	9	-	7	13	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} Pulse test with PW = 300 μ s, 1% duty cycle.

SS22FA - S215FA

TYPICAL PERFORMANCE CHARACTERISTICS

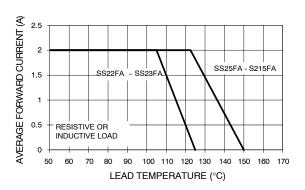


Figure 1. Forward Current Derating Curve

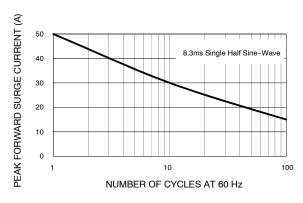


Figure 2. Maximum Non-Repetitive Forward Surge Current

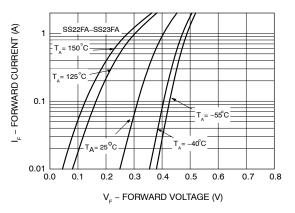


Figure 3. Typical Forward Characteristics

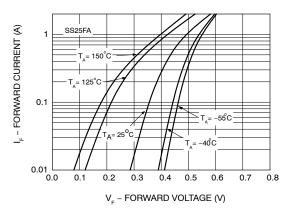


Figure 4. Typical Forward Characteristics

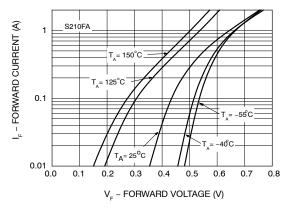


Figure 5. Typical Forward Characteristics

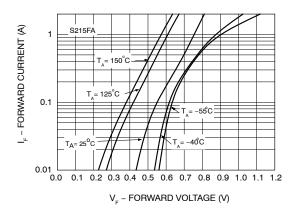


Figure 6. Typical Forward Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

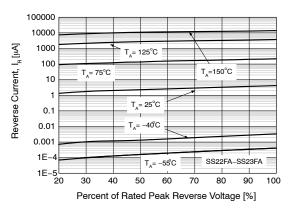


Figure 7. Typical Reverse Characteristics

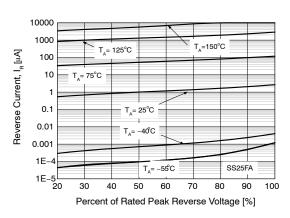


Figure 8. Typical Reverse Characteristics

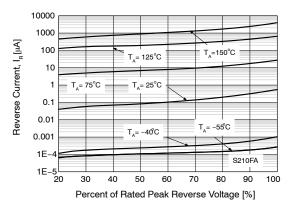


Figure 9. Typical Reverse Characteristics

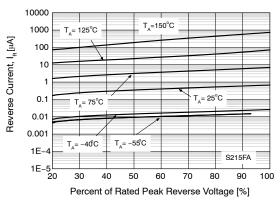


Figure 10. Typical Reverse Characteristics

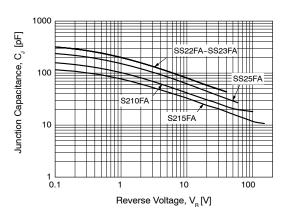
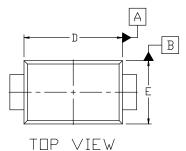
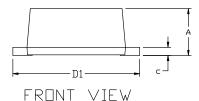


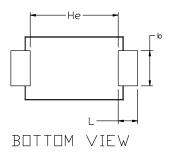
Figure 11. Typical Junction Capacitance











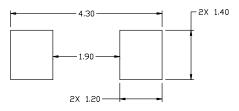
SOD-123FA CASE 425AB ISSUE A

DATE 11 AUG 2022

NOTES:

- NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND THE BAR PROTRUSIONS.

DIM	MILLIMETERS					
ו⊾ודת	MIN.	N□M.	MAX.			
А	1.23	1.33	1.43			
0	0.80	1.00	1,20			
U	0.16	0.23	0.30			
D	2.70	2,80	2.90			
D1	3.40	3,60	3.80			
E	1.70	1.80	1.90			
He	2.45		2.60			
L	0.35	0.60	0.85			



RECOMMENDED MOUNTING FOOTPRINT*

* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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DESCRIPTION:	SOD-123FA		PAGE 1 OF 1		

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